PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
KAZUKI DEMPOH	04/26/2018

RECEIVING PARTY DATA

Name:	TOKYO ELECTRON LIMITED
Street Address:	3-1 AKASAKA 5-CHOME, MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	107-6325

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15973331

CORRESPONDENCE DATA

Fax Number: (408)938-9069

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

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ATTORNEY DOCKET NUMBER:	TELF-0141-02S01US	
NAME OF SUBMITTER:	NING LI	
SIGNATURE:	/Ning Li/	
DATE SIGNED:	05/07/2018	
	This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

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PATENT 504903369 REEL: 045736 FRAME: 0221

ASSIGNMENT AND DECLARATION FOR PATENT APPLICATION

For good and valuable consideration, the receipt of which is hereby acknowledged, I/we, the undersigned, who have created a certain invention for which an application for United States Letters Patent is entitled:

FILM FORMING APPARATUS

as described and claimed in the specification identified by the above Attorney Docket No. do hereby sell, assign and transfer to TOKYO ELECTRON LIMITED, a corporation of Japan, having a place of business at 3-1

Akasaka 5-chome, Minato-ku, Tokyo 107-6325, Japan, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Agree that TOKYO ELECTRON LIMITED, hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below, next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

This application was made or was authorized to be made by me.

I acknowledge the duty to disclose to the U. S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, Section 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code §119(a)-(d) or §365(b) of any foreign application(s) for patent or inventor's certificate or §365(a) of any PCT International application(s) which designated at least one country other than the United States, listed below and have also identified below any foreign application for patent or inventor's certificate, or PCT International application, having a filing date

before th	iat of the application on which priority is claimed.
	No such Applications have been filed.
\boxtimes	Such Applications have been filed as follows:

Customer No. 36872 REEL: 045736 FRAME: 0222

Attorney Docket No.:				
Prior Foreign Application(s)	C	Day Manth Woon Filed	Priority Cl	
Application Number	Country	Day/Month/Year Filed	Yes	<u>No</u>
2017-092820	Japan	09/05/2017		
hereby claim the benefit under Ti application(s) listed below.	itle 35, United States	Code §119(e) of any United	States pro	visional
No such Applications have be	en filed.			
Such Applications have been	filed as follows:			
Provisional Application(s) Application Number	Prio	rity Claimed Under 35 USC 11 Day/Month/Year Filed	<u>9(e)</u>	
Jnited States application in the mannacknowledge the duty to disclose to the difference of Federal application (s) and the national or PCT No such Applications have be	the Office all informati Regulations, §1.56 wh international filing date	on known to me to be materianich occurred between the filir	I to patental	bility as
Such Applications have been				
Application Serial No.	Filing Date	Status (Patented, F	ending, Ab	andoned
I hereby declare that I have reviewed made herein of my own knowledge are to be true; and further that these states like so made are punishable by fine States Code and that such willful fals issued thereon.	re true and that all state ments were made with or imprisonment, or be	ments made on information and the knowledge that willful falso oth, under Section 1001 of Tit	I belief are I statements Ie 18 of the	believed and the United
Full Name of Sole/First Inventor:	EEE/C-/H	A CONTRACTOR OF THE CONTRACTOR	s (
Kazuki DEMPOH				
Inventor's Signature:	n	Date: Month/Day/Y		
Residence:	mpoh	April 26, 20	18 	
Yamanashi, Japan	(
Citizenship:				d-A
Japan				
Post Office Address:	, propagator de la company de	AAAA		***************************************

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RECORDED: 05/07/2018 REEL: 045736 FRAME: 0223

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Yamanashi 407-0192, Japan